

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of  
KANAYAMA et al.  
Serial No. 10/522,725  
Filed: September 22, 2005



Atty. Ref.: ARC-1417-495  
TC/A.U.: 1796  
Examiner: Frank

For: LOW-HEAT ACCUMULATING THERMOPLASTIC RESIN  
COMPOSITION AND MOLDED PRODUCT

August 19, 2008

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

## **INFORMATION DISCLOSURE STATEMENT**

Sir:

Applicants bring to the attention of the Patent and Trademark Office JP-A-2001-164082 (with English abstract) and JP-A-2002-69326 (patent family member is U.S. 6,485,557) cited during the examination of the underlying Japanese application. All three documents are listed on the attached form PTO/SB/08a. Copies of the JP documents (and abstract) are attached.

The Examiner is requested to initial the attached form PTO/SB/08a and to return a copy of the initialed document to the undersigned as an indication that the listed documents have been considered and made of record.

The relevant fee of \$180.00 to assure consideration of this paper is submitted herewith. You are hereby authorized to charge any further expense in connection with this Submission to our deposit account No. 14-1140 for any fees required in connection with the filing of this paper.

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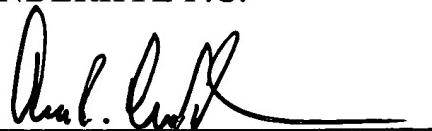
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Respectfully submitted,

**NIXON & VANDERHYE P.C.**

By: \_\_\_\_\_



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